Application No.: 10/613,050

AMENDMENTS TO THE SPECIFICATION:

Please amend the paragraph on page 2, lines 13-21 as follows:

In the related art, there is a structure of a printed wiring board as shown in Fig. 7 in order to solve the above-described problems. A printed wiring board 801 includes electrically insulating layers layer 803 and 803 which [[are]] is laminated, a signal transmitting lead 805 and [[a]] ground leads lead 804 804a and 804b which are formed of copper on both surfaces and the inside of the electrically insulating layers layer 803 and 803, an inner via hole 808 which electrically connects the ground leads 805 and 804 804a and 804b, and an electromagnetic shielding layer 806.